

# V&V Summary Report

## L2 ASCDS Version : 10.8

Observation 22645 - L2 Version 2  
Chandra X-Ray Center

L2 Processing Date : Oct 3 2019

See [axaff22645N002\\_VV001\\_vvref2.pdf](#) for the full report

V&V Scientist	Beth Sundheim
V&V Date (YYYY-MM-DD)	2019.10.03
V&V Edition	1
V&V Disposition and Status	OK
V&V Charge Time	49.066123758197

## Comments

One optional chip was dropped.

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To compensate for a few bad pixels not marked as bad that were not removed in the Level 2 processing, a custom bad pixel file with additional bad pixels at (chipx, chipy) = (232:234,322:339) in S1 was added in this processing. As a result, the user will NOT find a relatively bright square of pixels on the S1 chip for level 2 data caused by the application of the dither algorithm to the bad pixels in question, as opposed to previous processing(s).

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The focal plane temperature during the interval 686282122.29 - 686285386.59 (MET s) of this observation was warmer than the upper limit for optimum calibration of the ACIS gain and spectral resolution (i.e., -111.0 C for ACIS-S).

The Chandra calibration team calibrates the ACIS gain and spectral resolution using data from the external calibration source (ECS). ECS data show that the frontside-illuminated (FI) CCDs are more temperature sensitive than the backside-illuminated (BI) CCDs.

A summary of the current calibration status of the ACIS gain and spectral resolution can be found at:

The main points are:

- 1) The gain on BI chips remains within 0.3% (i.e., the systematic uncertainty in the ACIS gain quoted on the Chandra Calibration Status Summary web page) at all measured temperatures.
  - 2) The gain on FI chips remains within 0.3% below row 600 at all measured temperatures.
  - 3) The gain on FI chips above row 600 can be underestimated by as much as 1% for focal plane temperatures exceeding -116 C.
  - 4) The spectral resolution (i.e., FWHM) on BI chips is insensitive to the focal plane temperature.
  - 5) Warmer focal plane temperatures increase the FWHM on FI chips by up to 30 eV near row 512 and by up to 70 eV near the top of the chips.
- In summary, the user should be cautious in the spectral analysis of high S/N emission lines detected on the top half of FI chips in this observation. Default processing with the current version of the CALDB will underestimate photon energies by up to 1% and broaden emission lines by up to 70 eV.

seq_num	801876	Sequence number
obs_id	22645	Observation id
title	Spiraling into the 'quotation mark' cluster	Proposal title
observer	Ming Sun	Principal investigator
object	MCXC J0157.4-0550	Source name
dtcycle	0	&#160
cycle	P	events from which exps? Prim/Second/Both
ra_targ	29.399917	Observer's specified target RA [deg]
dec_targ	-5.810972	Observer's specified target Dec [deg]
ra_nom	29.403172807678	Nominal RA [deg]
dec_nom	-5.7918332033052	Nominal Dec [deg]
roll_nom	69.156948671416	Nominal Roll [deg]
revision	2	Processing version of data
ontime	49066.123758197	Sum of GTIs [s]
livetime	48425.038729341	Livetime [s]
ontime3	49066.000638247	Sum of GTIs [s]
ontime5	49066.082718253	Sum of GTIs [s]
ontime6	49066.04167819	Sum of GTIs [s]
ontime7	49066.123758197	Sum of GTIs [s]
l2events	557543	Number of level 2 events

